IPC ASSOCIATION ELECTRONICS	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				under both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				erials and M	ials and Mfg Information			
Supplier	Information													
Company name* Company unique ID					Unique ID Authority				Respon	Response Date*				
nsemi											2025-05-09			
Contact Na	me		Title - Contac	itle - Contact			Phone - Contact*				Email - Contact*			
Product-E	nv-Stewards		Product Envi	Product Enviro Compliance			NA			Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title -				Fitle - Representative			Phone - Representative*			Email -	Email - Representative*			
Product-E	nv-Stewards	Product Envi	Product Enviro Compliance			NA			Produ	Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	ive Date   Version   Manufacturing Site			Weight*	UOM	Unit Type	
		NCH-RS ABG	SL10-101Q48-	RSL10 QFN			2025-05-09		TWU		133.45	mg	Each	
Ianufac	turing Proccess Informa	ation												
7	Terminal Plating / Grid Array Material T			Cerminal Base Alloy J-STD-020 M		Rating	Peak Proce	Peak Process Body Temperature   Max Time at Peal		ak Tempera	ature Numb	er of Reflow Cyc	cles	
Matte Tin (Sn) - annealed		CU Alloy 3		3		260	С	30	seco	nds 3				
omments														
TENTIC	ON: MSL 3 Rated item requir	es Bake and I	Ory Pack (after	electrical test)					•					
or more in	formation regarding materia	l composition	please refer to	page 3					<u> </u>					

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure it accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	15.0	mg	Supplier	Silicon (Si)	7440-21-3		15	mg
Die Attach	2.58	mg	Supplier	Silver (Ag)	7440-22-4		2.193	mg
			Supplier	Acrylic resins	Proprietary Data		0.387	mg
Lead Frame	78.55		Supplier	Silver (Ag)	7440-22-4		0.7855	mg
			Supplier	Tin (Sn)	7440-31-5		0.1964	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1728	mg
			Supplier	Chromium (Cr)	7440-47-3		0.1964	mg
			Supplier	Copper (Cu)	7440-50-8		77.1989	mg
Mold Compound-Black	34.32		Supplier	Epoxy resins	129915-35-1		1.716	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.716	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1373	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.7894	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		29.172	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.7894	mg
Plating	2.46	mg	Supplier	Tin (Sn)	7440-31-5		2.46	mg
Wire Bond - Au	0.54	mg	Supplier	Gold (Au)	7440-57-5		0.54	mg